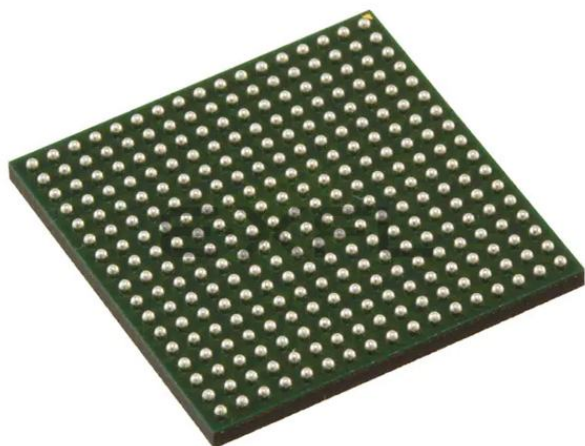




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	1584
Total RAM Bits	18432
Number of I/O	157
Number of Gates	60000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	289-TFBGA, CSBGA
Supplier Device Package	289-CSP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/aglp060v5-csg289i

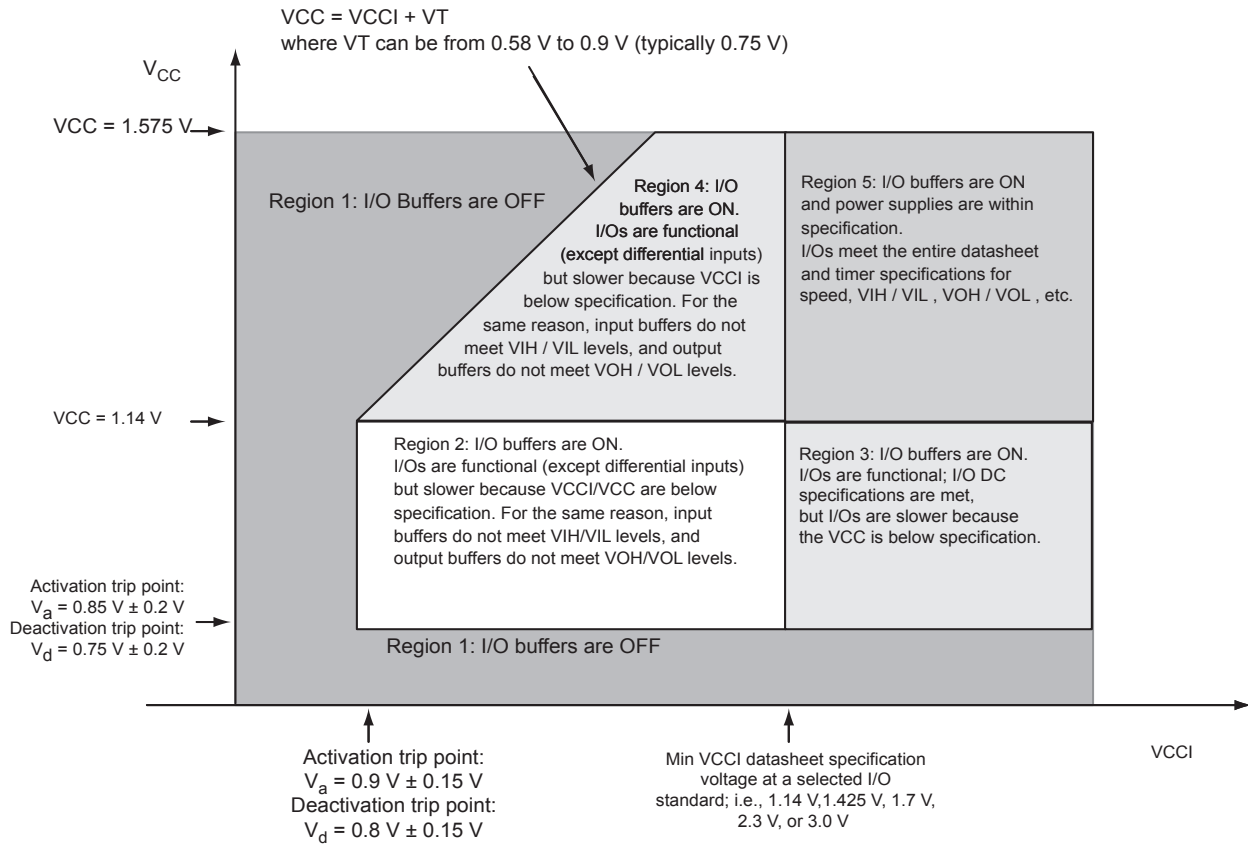


Figure 2-2 • V2 Devices – I/O State as a Function of VCCI and VCC Voltage Levels

Thermal Characteristics

Introduction

The temperature variable in the Microsemi Designer software refers to the junction temperature, not the ambient temperature. This is an important distinction because dynamic and static power consumption cause the chip junction temperature to be higher than the ambient temperature.

EQ 1 can be used to calculate junction temperature.

$$T_J = \text{Junction Temperature} = \Delta T + T_A$$

EQ 1

where:

T_A = Ambient temperature

ΔT = Temperature gradient between junction (silicon) and ambient $\Delta T = \theta_{ja} * P$

θ_{ja} = Junction-to-ambient of the package. θ_{ja} numbers are located in Figure 2-5.

P = Power dissipation

Timing Characteristics

Applies to 1.5 V DC Core Voltage

Table 2-36 • 3.3 V LVTTTL / 3.3 V LVCMOS Low Slew – Applies to 1.5 V DC Core Voltage

Commercial-Case Conditions: $T_J = 70^\circ\text{C}$, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 3.0 V

Drive Strength	Speed Grade	t_{DOUT}	t_{DP}	t_{DIN}	t_{PY}	t_{PYS}	t_{EOUT}	t_{ZL}	t_{ZH}	t_{LZ}	t_{HZ}	Units
2 mA	STD	0.97	3.94	0.18	0.85	1.15	0.66	4.02	3.46	1.82	1.87	ns
4 mA	STD	0.97	3.94	0.18	0.85	1.15	0.66	4.02	3.46	1.82	1.87	ns
6 mA	STD	0.97	3.20	0.18	0.85	1.15	0.66	3.27	2.94	2.04	2.27	ns
8 mA	STD	0.97	3.20	0.18	0.85	1.15	0.66	3.27	2.94	2.04	2.27	ns
12 mA	STD	0.97	2.72	0.18	0.85	1.15	0.66	2.78	2.57	2.20	2.53	ns
16 mA	STD	0.97	2.72	0.18	0.85	1.15	0.66	2.78	2.57	2.20	2.53	ns

Note: For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.

Table 2-37 • 3.3 V LVTTTL / 3.3 V LVCMOS High Slew – Applies to 1.5 V DC Core Voltage

Commercial-Case Conditions: $T_J = 70^\circ\text{C}$, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 3.0 V

Drive Strength	Speed Grade	t_{DOUT}	t_{DP}	t_{DIN}	t_{PY}	t_{PYS}	t_{EOUT}	t_{ZL}	t_{ZH}	t_{LZ}	t_{HZ}	Units
2 mA	STD	0.97	2.36	0.18	0.85	1.15	0.66	2.41	1.90	1.82	1.98	ns
4 mA	STD	0.97	2.36	0.18	0.85	1.15	0.66	2.41	1.90	1.82	1.98	ns
6 mA	STD	0.97	1.96	0.18	0.85	1.15	0.66	2.01	1.56	2.04	2.38	ns
8 mA	STD	0.97	1.96	0.18	0.85	1.15	0.66	2.01	1.56	2.04	2.38	ns
12 mA	STD	0.97	1.76	0.18	0.85	1.15	0.66	1.80	1.39	2.20	2.64	ns
16 mA	STD	0.97	1.76	0.18	0.85	1.15	0.66	1.80	1.39	2.20	2.64	ns

Notes:

- For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.
- Software default selection highlighted in gray.

Applies to 1.2 V DC Core Voltage

Table 2-38 • 3.3 V LVTTTL / 3.3 V LVCMOS Low Slew – Applies to 1.2 V DC Core Voltage

Commercial-Case Conditions: $T_J = 70^\circ\text{C}$, Worst-Case VCC = 1.14 V, Worst-Case VCCI = 3.0 V

Drive Strength	Speed Grade	t_{DOUT}	t_{DP}	t_{DIN}	t_{PY}	t_{PYS}	t_{EOUT}	t_{ZL}	t_{ZH}	t_{LZ}	t_{HZ}	Units
2 mA	STD	0.98	4.56	0.19	0.99	1.37	0.67	4.63	3.98	2.26	2.57	ns
4 mA	STD	0.98	4.56	0.19	0.99	1.37	0.67	4.63	3.98	2.26	2.57	ns
6 mA	STD	0.98	3.80	0.19	0.99	1.37	0.67	3.96	3.45	2.49	2.98	ns
8 mA	STD	0.98	3.80	0.19	0.99	1.37	0.67	3.86	3.45	2.49	2.98	ns
12 mA	STD	0.98	3.31	0.19	0.99	1.37	0.67	3.36	3.07	2.65	3.25	ns
16 mA	STD	0.98	3.31	0.19	0.99	1.37	0.67	3.36	3.07	2.65	3.25	ns

Note: For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.

Table 2-39 • 3.3 V LVTTTL / 3.3 V LVCMOS High Slew – Applies to 1.2 V DC Core Voltage

Commercial-Case Conditions: $T_J = 70^\circ\text{C}$, Worst-Case $V_{CC} = 1.14\text{ V}$, Worst-Case $V_{CCI} = 3.0\text{ V}$

Drive Strength	Speed Grade	t_{DOUT}	t_{DP}	t_{DIN}	t_{PY}	t_{PYS}	t_{EOUT}	t_{ZL}	t_{ZH}	t_{LZ}	t_{HZ}	Units
2 mA	STD	0.98	2.92	0.19	0.99	1.37	0.67	2.97	2.38	2.25	2.70	ns
4 mA	STD	0.98	2.92	0.19	0.99	1.37	0.67	2.97	2.38	2.25	2.70	ns
6 mA	STD	0.98	2.52	0.19	0.99	1.37	0.67	2.56	2.03	2.49	3.11	ns
8 mA	STD	0.98	2.52	0.19	0.99	1.37	0.67	2.56	2.03	2.49	3.11	ns
12 mA	STD	0.98	2.31	0.19	0.99	1.37	0.67	2.34	1.86	2.65	3.38	ns
16 mA	STD	0.98	2.31	0.19	0.99	1.37	0.67	2.34	1.86	2.65	3.38	ns

Notes:

- For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.
- Software default selection highlighted in gray

3.3 V LVCMOS Wide Range

Table 2-40 • Minimum and Maximum DC Input and Output Levels

3.3 V LVCMOS Wide Range	Equivalent Software Default Drive Strength Option ¹	VIL		VIH		VOL	VOH	IOL	IOH	IOSL	IOSH	IIL ²	IIH ³
		Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	μA	μA	Max. μA^4	Max. μA^4	μA^5	μA^5
100 μA	2 mA	-0.3	0.8	2	3.6	0.2	$V_{DD} - 0.2$	100	100	25	27	10	10
100 μA	4 mA	-0.3	0.8	2	3.6	0.4	$V_{DD} - 0.2$	100	100	25	27	10	10
100 μA	6 mA	-0.3	0.8	2	3.6	0.4	$V_{DD} - 0.2$	100	100	51	54	10	10
100 μA	8 mA	-0.3	0.8	2	3.6	0.4	$V_{DD} - 0.2$	100	100	51	54	10	10
100 μA	12 mA	-0.3	0.8	2	3.6	0.4	$V_{DD} - 0.2$	100	100	103	109	10	10
100 μA	16 mA	-0.3	0.8	2	3.6	0.4	$V_{DD} - 0.2$	100	100	103	109	10	10

Notes:

- The minimum drive strength for any LVCMOS 3.3 V software configuration when run in wide range is $\pm 100\text{ }\mu\text{A}$. Drive strength displayed in the software is supported for normal range only. For a detailed I/V curve, refer to the IBIS models.
- IIL is the input leakage current per I/O pin over recommended operation conditions where $-0.3\text{ V} < V_{IN} < V_{IL}$.
- IIH is the input leakage current per I/O pin over recommended operating conditions $V_{IH} < V_{IN} < V_{CCI}$. Input current is larger when operating outside recommended ranges.
- Currents are measured at high temperature (100°C junction temperature) and maximum voltage.
- Currents are measured at 85°C junction temperature.
- Software default selection highlighted in gray.

Table 2-41 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	C_{LOAD} (pF)
0	3.3	1.4	5

Note: *Measuring point = V_{trip} . See [Table 2-23 on page 2-20](#) for a complete table of trip points.

1.5 V LVCMOS (JESD8-11)

Low-Voltage CMOS for 1.5 V is an extension of the LVCMOS standard (JESD8-5) used for general-purpose 1.5 V applications. It uses a 1.5 V input buffer and a push-pull output buffer.

Table 2-58 • Minimum and Maximum DC Input and Output Levels

1.5 V LVCMOS	VIL		VIH		VOL	VOH	IOL	IOH	IOSL	IOSH	IIL ¹	IIH ²
Drive Strength	Min. V	Max. V	Min. V	Max. V	Max. V	Min. V	mA	mA	Max. mA ³	Max. mA ³	μA ⁴	μA ⁴
2 mA	−0.3	0.35 * VCCI	0.7 * VCCI	3.6	0.25 * VCCI	0.75 * VCCI	2	2	13	16	10	10
4 mA	−0.3	0.35 * VCCI	0.7 * VCCI	3.6	0.25 * VCCI	0.75 * VCCI	4	4	25	33	10	10

Notes:

1. IIL is the input leakage current per I/O pin over recommended operation conditions where $-0.3\text{ V} < V_{IN} < V_{IL}$.
2. IIH is the input leakage current per I/O pin over recommended operating conditions $V_{IH} < V_{IN} < V_{CCI}$. Input current is larger when operating outside recommended ranges.
3. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.
4. Currents are measured at 85°C junction temperature.
5. Software default selection highlighted in gray.

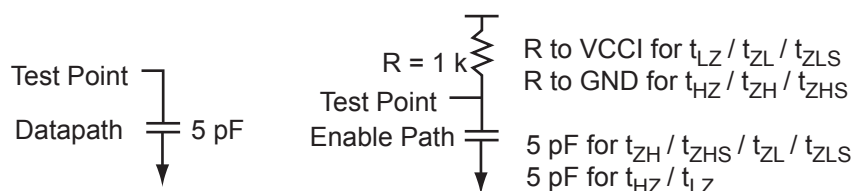


Figure 2-10 • AC Loading

Table 2-59 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	C _{LOAD} (pF)
0	1.5	0.75	5

Note: *Measuring point = V_{trip} . See [Table 2-23 on page 2-20](#) for a complete table of trip points.

Table 2-72 • Parameter Definition and Measuring Nodes

Parameter Name	Parameter Definition	Measuring Nodes (from, to)*
t_{OCLKQ}	Clock-to-Q of the Output Data Register	H, DOUT
t_{OSUD}	Data Setup Time for the Output Data Register	F, H
t_{OHD}	Data Hold Time for the Output Data Register	F, H
t_{OPRE2Q}	Asynchronous Preset-to-Q of the Output Data Register	L, DOUT
t_{OREMPRE}	Asynchronous Preset Removal Time for the Output Data Register	L, H
t_{ORECPRE}	Asynchronous Preset Recovery Time for the Output Data Register	L, H
t_{OECLKQ}	Clock-to-Q of the Output Enable Register	H, EOUT
t_{OESUD}	Data Setup Time for the Output Enable Register	J, H
t_{OEHD}	Data Hold Time for the Output Enable Register	J, H
t_{OEPRE2Q}	Asynchronous Preset-to-Q of the Output Enable Register	I, EOUT
t_{OEREMPRE}	Asynchronous Preset Removal Time for the Output Enable Register	I, H
t_{OERECPRE}	Asynchronous Preset Recovery Time for the Output Enable Register	I, H
t_{ICLKQ}	Clock-to-Q of the Input Data Register	A, E
t_{ISUD}	Data Setup Time for the Input Data Register	C, A
t_{IHD}	Data Hold Time for the Input Data Register	C, A
t_{IPRE2Q}	Asynchronous Preset-to-Q of the Input Data Register	D, E
t_{IREMPRE}	Asynchronous Preset Removal Time for the Input Data Register	D, A
t_{IRECPRE}	Asynchronous Preset Recovery Time for the Input Data Register	D, A

Note: *See Figure 2-12 on page 2-41 for more information.

Fully Registered I/O Buffers with Asynchronous Clear

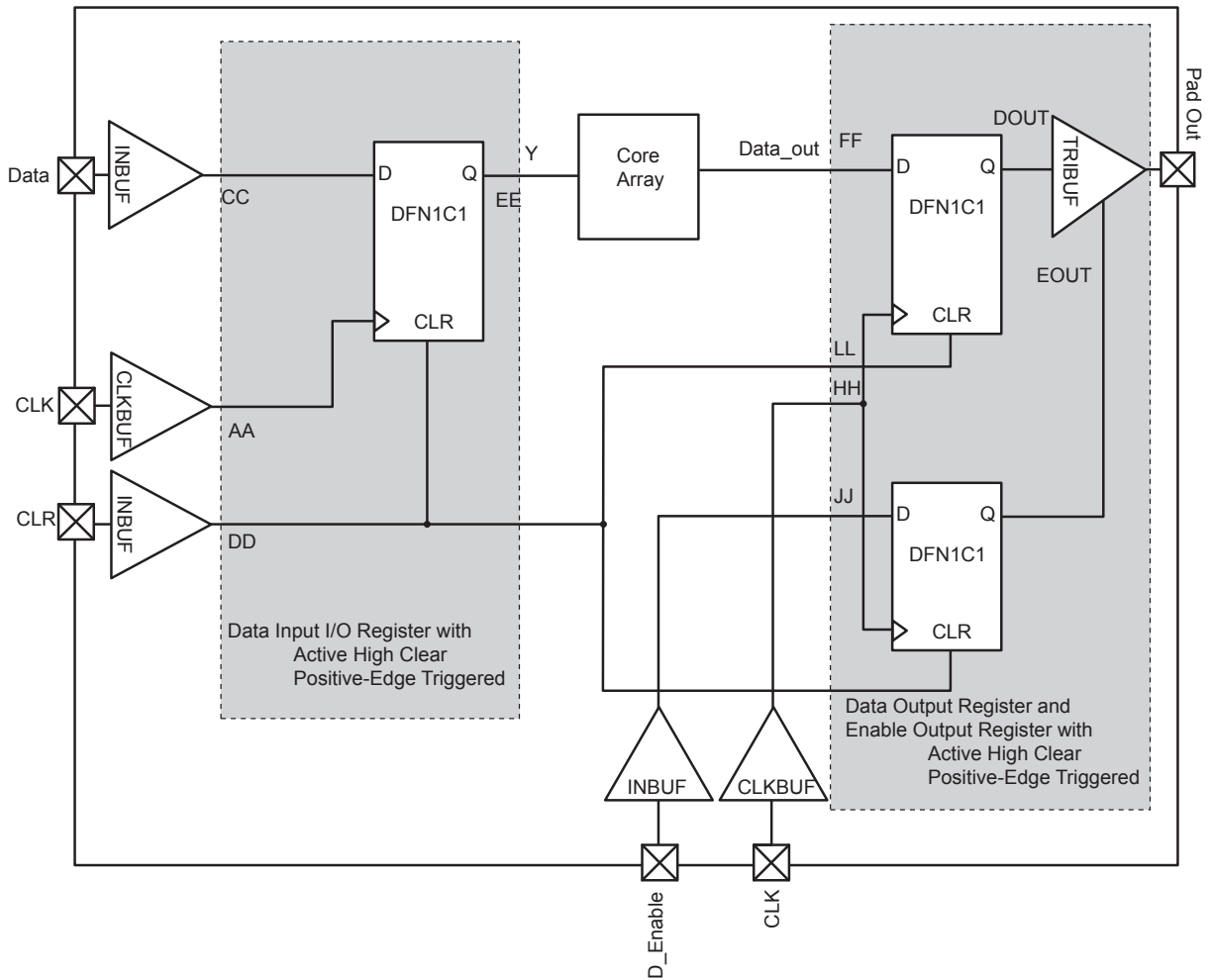


Figure 2-13 • Timing Model of the Registered I/O Buffers with Asynchronous Clear

Input Register

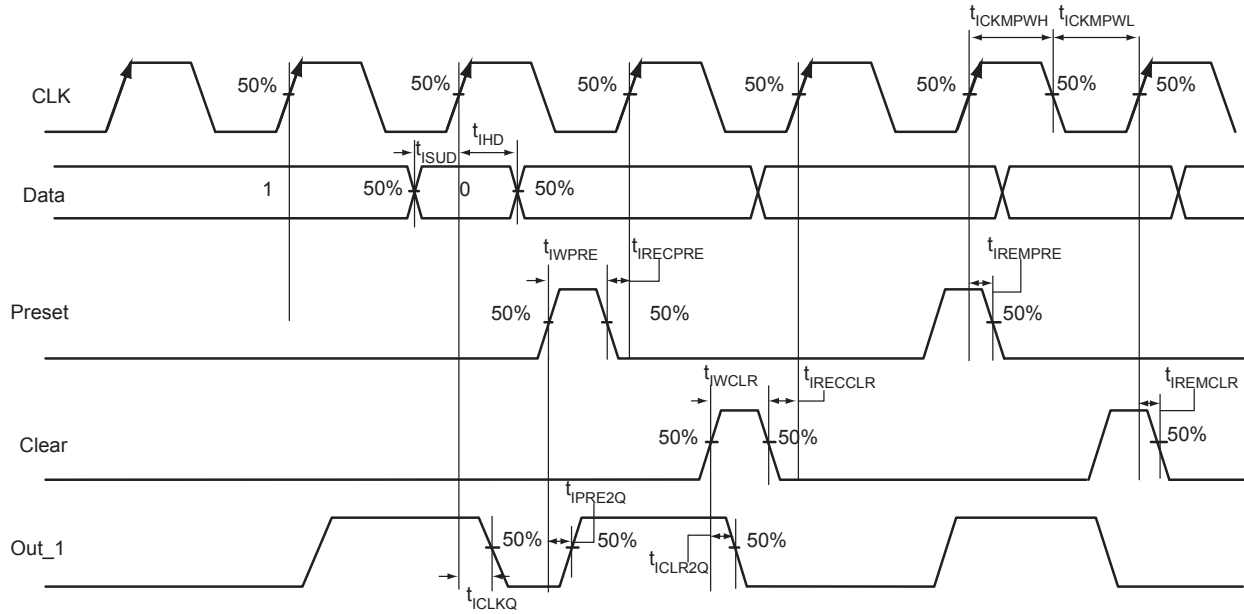


Figure 2-14 • Input Register Timing Diagram

Timing Characteristics

1.5 V DC Core Voltage

Table 2-74 • Input Data Register Propagation Delays

Commercial-Case Conditions: $T_J = 70^\circ\text{C}$, Worst-Case $V_{CC} = 1.425\text{ V}$

Parameter	Description	Std.	Units
t_{CLKQ}	Clock-to-Q of the Input Data Register	0.41	ns
t_{SUD}	Data Setup Time for the Input Data Register	0.32	ns
t_{IHD}	Data Hold Time for the Input Data Register	0.00	ns
t_{CLR2Q}	Asynchronous Clear-to-Q of the Input Data Register	0.57	ns
t_{PRE2Q}	Asynchronous Preset-to-Q of the Input Data Register	0.57	ns
t_{REMCLR}	Asynchronous Clear Removal Time for the Input Data Register	0.00	ns
t_{RECCLR}	Asynchronous Clear Recovery Time for the Input Data Register	0.24	ns
t_{REMPRE}	Asynchronous Preset Removal Time for the Input Data Register	0.00	ns
t_{RECPRE}	Asynchronous Preset Recovery Time for the Input Data Register	0.24	ns
t_{WCLR}	Asynchronous Clear Minimum Pulse Width for the Input Data Register	0.19	ns
t_{WPRE}	Asynchronous Preset Minimum Pulse Width for the Input Data Register	0.19	ns
t_{CKMPWH}	Clock Minimum Pulse Width High for the Input Data Register	0.31	ns
t_{CKMPWL}	Clock Minimum Pulse Width Low for the Input Data Register	0.28	ns

Note: For specific junction temperature and voltage supply levels, refer to Table 2-6 on page 2-6 for derating values.

1.2 V DC Core Voltage

Table 2-75 • Input Data Register Propagation Delays

Commercial-Case Conditions: $T_J = 70^{\circ}\text{C}$, Worst-Case $V_{CC} = 1.14\text{ V}$

Parameter	Description	Std.	Units
t_{CLKQ}	Clock-to-Q of the Input Data Register	0.66	ns
t_{SUD}	Data Setup Time for the Input Data Register	0.43	ns
t_{IHD}	Data Hold Time for the Input Data Register	0.00	ns
t_{CLR2Q}	Asynchronous Clear-to-Q of the Input Data Register	0.86	ns
t_{PRE2Q}	Asynchronous Preset-to-Q of the Input Data Register	0.86	ns
t_{REMCLR}	Asynchronous Clear Removal Time for the Input Data Register	0.00	ns
t_{RECCLR}	Asynchronous Clear Recovery Time for the Input Data Register	0.24	ns
t_{REMPRE}	Asynchronous Preset Removal Time for the Input Data Register	0.00	ns
t_{RECPRE}	Asynchronous Preset Recovery Time for the Input Data Register	0.24	ns
t_{WCLR}	Asynchronous Clear Minimum Pulse Width for the Input Data Register	0.19	ns
t_{WPRE}	Asynchronous Preset Minimum Pulse Width for the Input Data Register	0.19	ns
t_{CKMPWH}	Clock Minimum Pulse Width High for the Input Data Register	0.31	ns
t_{CKMPWL}	Clock Minimum Pulse Width Low for the Input Data Register	0.28	ns

Note: For specific junction temperature and voltage supply levels, refer to [Table 2-7 on page 2-6](#) for derating values.

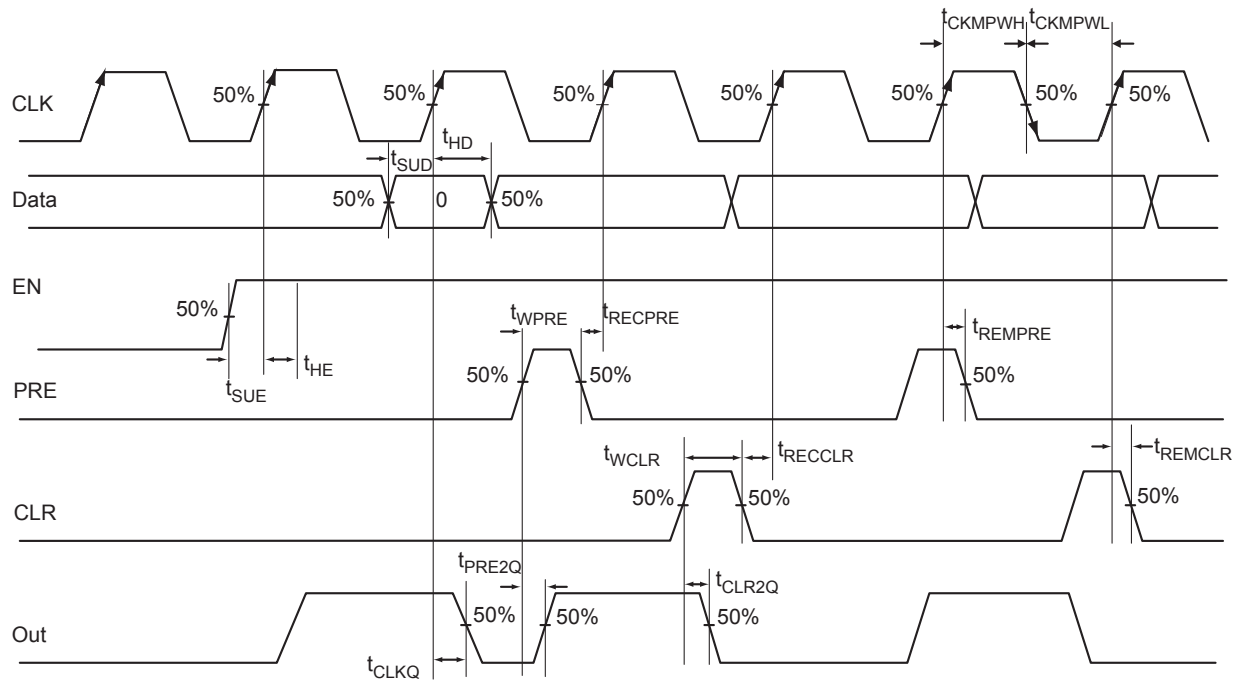


Figure 2-20 • Timing Model and Waveforms

Timing Characteristics

1.5 V DC Core Voltage

Table 2-82 • Register Delays

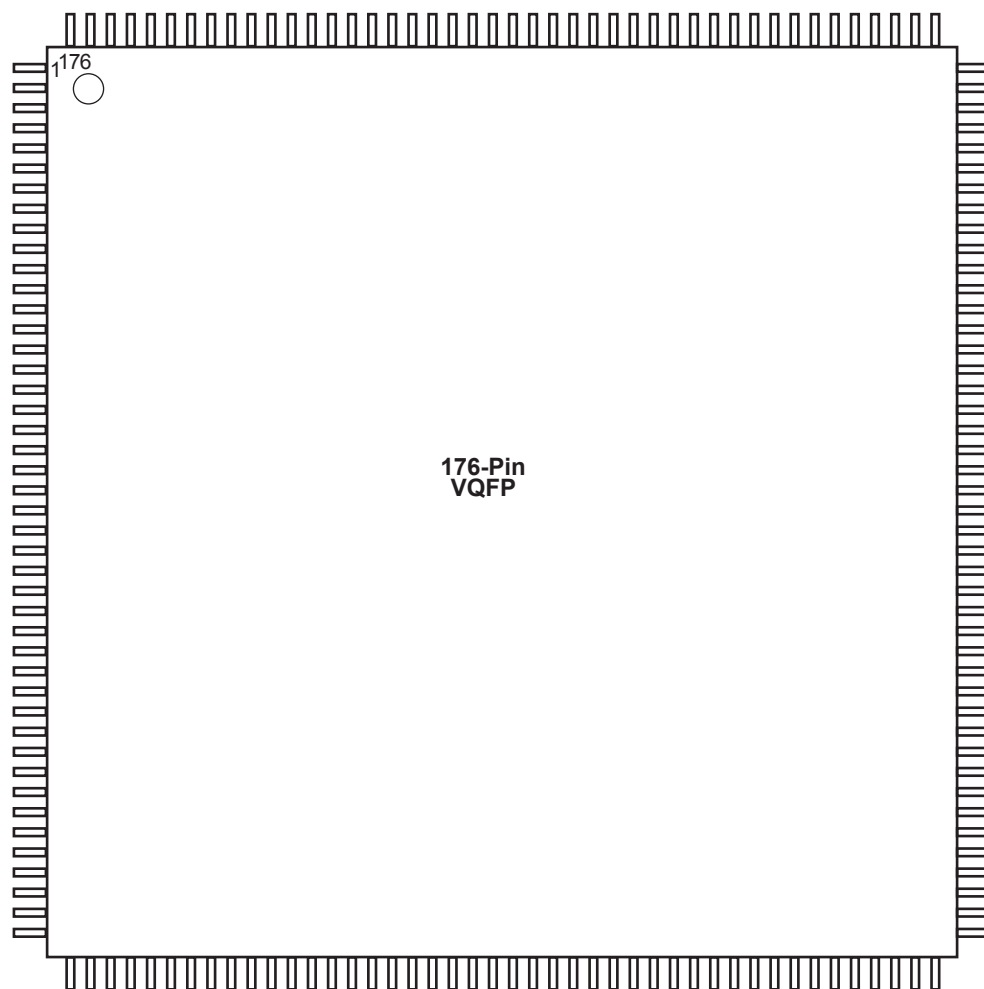
Commercial-Case Conditions: $T_J = 70^\circ\text{C}$, Worst-Case $V_{CC} = 1.425\text{ V}$

Parameter	Description	Std.	Units
t_{CLKQ}	Clock-to-Q of the Core Register	0.89	ns
t_{SUD}	Data Setup Time for the Core Register	0.81	ns
t_{HD}	Data Hold Time for the Core Register	0.00	ns
t_{SUE}	Enable Setup Time for the Core Register	0.73	ns
t_{HE}	Enable Hold Time for the Core Register	0.00	ns
t_{CLR2Q}	Asynchronous Clear-to-Q of the Core Register	0.60	ns
t_{PRE2Q}	Asynchronous Preset-to-Q of the Core Register	0.62	ns
t_{REMCLR}	Asynchronous Clear Removal Time for the Core Register	0.00	ns
t_{RECCLR}	Asynchronous Clear Recovery Time for the Core Register	0.24	ns
t_{REMPRE}	Asynchronous Preset Removal Time for the Core Register	0.00	ns
t_{RECPRE}	Asynchronous Preset Recovery Time for the Core Register	0.23	ns
t_{WCLR}	Asynchronous Clear Minimum Pulse Width for the Core Register	0.30	ns
t_{WPRE}	Asynchronous Preset Minimum Pulse Width for the Core Register	0.30	ns
t_{CKMPWH}	Clock Minimum Pulse Width High for the Core Register	0.56	ns
t_{CKMPWL}	Clock Minimum Pulse Width Low for the Core Register	0.56	ns

Note: For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.

VQ128	
Pin Number	AGLP030 Function
106	IO26RSB0
107	IO25RSB0
108	IO23RSB0
109	IO22RSB0
110	IO21RSB0
111	IO19RSB0
112	IO18RSB0
113	VCC
114	IO17RSB0
115	IO16RSB0
116	IO14RSB0
117	IO13RSB0
118	IO12RSB0
119	IO10RSB0
120	IO09RSB0
121	VCCIB0
122	GND
123	IO07RSB0
124	IO05RSB0
125	IO03RSB0
126	IO02RSB0
127	IO01RSB0
128	IO00RSB0

VQ176



Note: This is the bottom view of the package.

Note

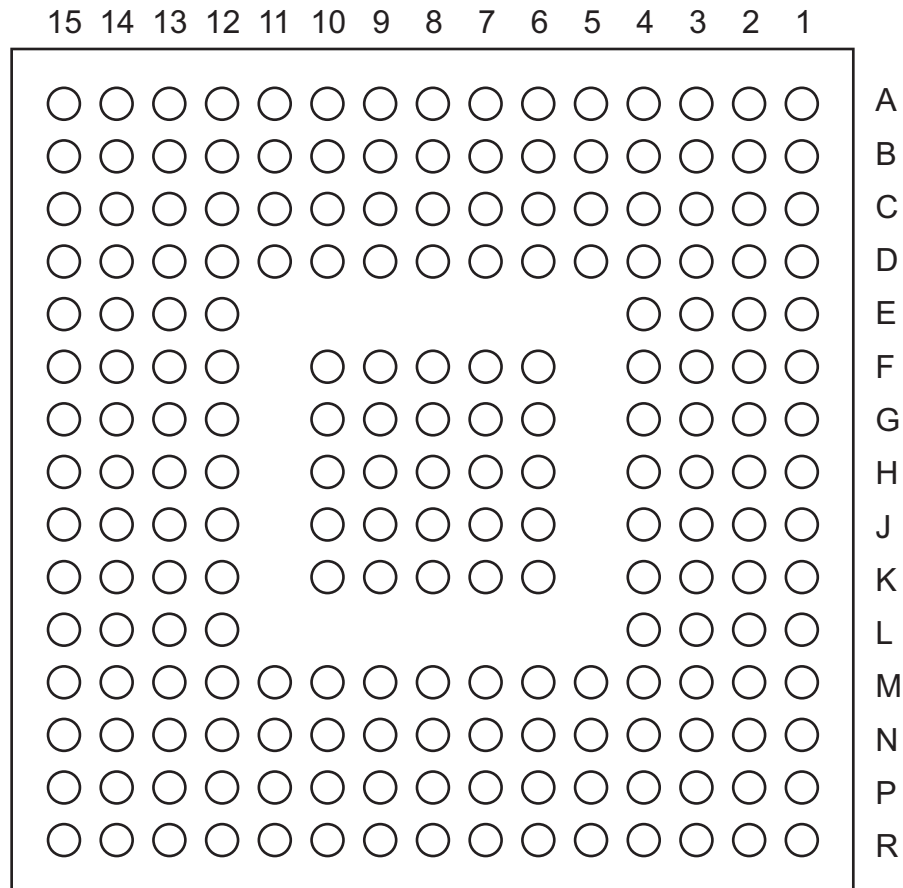
For Package Manufacturing and Environmental information, visit the Resource Center at <http://www.microsemi.com/soc/products/solutions/package/docs.aspx>.

VQ176	
Pin Number	AGLP060 Function
105	IO62RSB1
106	IO61RSB1
107	GCC2/IO60RSB1
108	GCB2/IO59RSB1
109	GCA2/IO58RSB1
110	GCA0/IO57RSB1
111	GCA1/IO56RSB1
112	VCCIB1
113	GND
114	GCB0/IO55RSB1
115	GCB1/IO54RSB1
116	GCC0/IO53RSB1
117	GCC1/IO52RSB1
118	IO51RSB1
119	IO50RSB1
120	VCC
121	IO48RSB1
122	IO47RSB1
123	IO45RSB1
124	IO44RSB1
125	IO43RSB1
126	VCCIB1
127	GND
128	GBC2/IO40RSB1
129	IO39RSB1
130	GBB2/IO38RSB1
131	IO37RSB1
132	GBA2/IO36RSB1
133	GBA1/IO35RSB0
134	NC
135	GBA0/IO34RSB0
136	NC
137	GBB1/IO33RSB0
138	NC
139	GBC1/IO31RSB0

VQ176	
Pin Number	AGLP060 Function
140	GBB0/IO32RSB0
141	GBC0/IO30RSB0
142	IO29RSB0
143	IO28RSB0
144	IO27RSB0
145	VCCIB0
146	GND
147	IO26RSB0
148	IO25RSB0
149	IO24RSB0
150	IO23RSB0
151	IO22RSB0
152	IO21RSB0
153	IO20RSB0
154	IO19RSB0
155	IO18RSB0
156	VCC
157	IO17RSB0
158	IO16RSB0
159	IO15RSB0
160	IO14RSB0
161	IO13RSB0
162	IO12RSB0
163	IO11RSB0
164	IO10RSB0
165	IO09RSB0
166	VCCIB0
167	GND
168	IO07RSB0
169	IO08RSB0
170	GAC1/IO05RSB0
171	IO06RSB0
172	GAB1/IO03RSB0
173	GAC0/IO04RSB0
174	GAB0/IO02RSB0

VQ176	
Pin Number	AGLP060 Function
175	GAA1/IO01RSB0
176	GAA0/IO00RSB0

CS201



Note: This is the bottom view of the package.

Note

For Package Manufacturing and Environmental information, visit the Resource Center at <http://www.microsemi.com/soc/products/solutions/package/docs.aspx>.

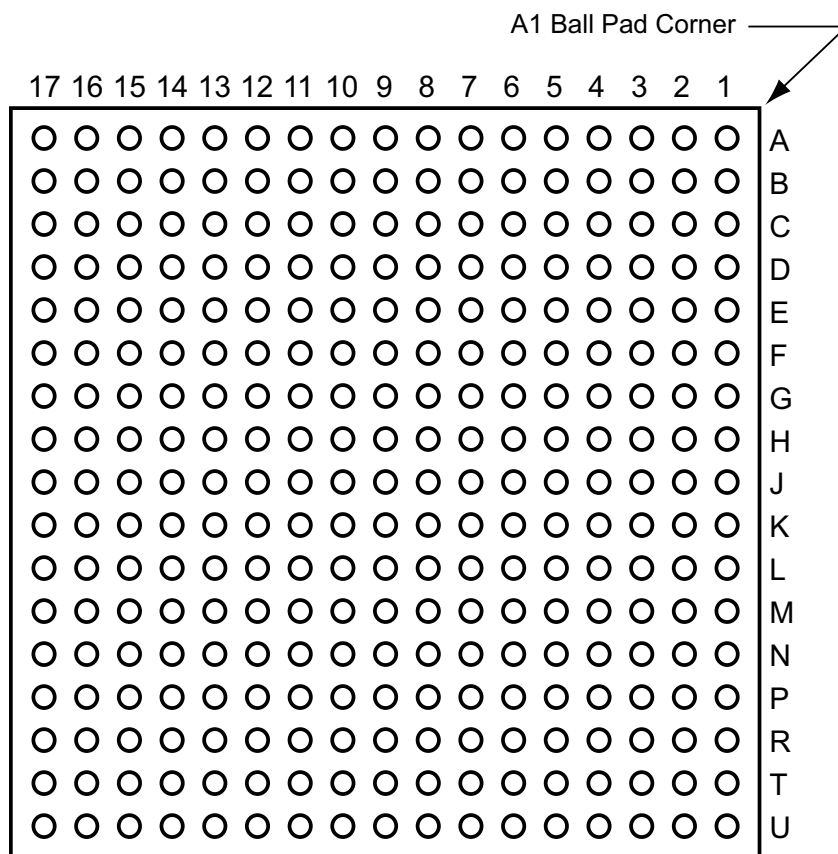
CS201		CS201		CS201	
Pin Number	AGLP030 Function	Pin Number	AGLP030 Function	Pin Number	AGLP030 Function
A1	NC	C6	IO12RSB0	F3	IO119RSB3
A2	IO04RSB0	C7	IO23RSB0	F4	IO111RSB3
A3	IO06RSB0	C8	IO19RSB0	F6	GND
A4	IO09RSB0	C9	IO28RSB0	F7	VCC
A5	IO11RSB0	C10	IO32RSB0	F8	VCCIB0
A6	IO13RSB0	C11	IO35RSB0	F9	VCCIB0
A7	IO17RSB0	C12	NC	F10	VCCIB0
A8	IO18RSB0	C13	GND	F12	NC
A9	IO24RSB0	C14	IO41RSB1	F13	NC
A10	IO26RSB0	C15	IO37RSB1	F14	IO40RSB1
A11	IO27RSB0	D1	IO117RSB3	F15	IO38RSB1
A12	IO31RSB0	D2	IO118RSB3	G1	NC
A13	NC	D3	NC	G2	IO112RSB3
A14	NC	D4	GND	G3	IO110RSB3
A15	NC	D5	IO01RSB0	G4	IO109RSB3
B1	NC	D6	IO03RSB0	G6	VCCIB3
B2	NC	D7	IO10RSB0	G7	GND
B3	IO08RSB0	D8	IO21RSB0	G8	VCC
B4	IO05RSB0	D9	IO25RSB0	G9	GND
B5	IO07RSB0	D10	IO30RSB0	G10	GND
B6	IO15RSB0	D11	IO33RSB0	G12	NC
B7	IO14RSB0	D12	GND	G13	NC
B8	IO16RSB0	D13	NC	G14	IO42RSB1
B9	IO20RSB0	D14	IO36RSB1	G15	IO44RSB1
B10	IO22RSB0	D15	IO39RSB1	H1	NC
B11	IO34RSB0	E1	IO115RSB3	H2	GEB0/IO106RSB3
B12	IO29RSB0	E2	IO114RSB3	H3	GEC0/IO108RSB3
B13	NC	E3	NC	H4	NC
B14	NC	E4	NC	H6	VCCIB3
B15	NC	E12	NC	H7	GND
C1	NC	E13	NC	H8	VCC
C2	NC	E14	GDC0/IO46RSB1	H9	GND
C3	GND	E15	GDB0/IO48RSB1	H10	VCCIB1
C4	IO00RSB0	F1	IO113RSB3	H12	IO54RSB1
C5	IO02RSB0	F2	IO116RSB3	H13	GDA0/IO47RSB1

CS281	
Pin Number	AGLP125 Function
A1	GND
A2	GAB0/IO02RSB0
A3	GAC1/IO05RSB0
A4	IO09RSB0
A5	IO13RSB0
A6	IO15RSB0
A7	IO18RSB0
A8	IO23RSB0
A9	IO25RSB0
A10	VCCIB0
A11	IO33RSB0
A12	IO41RSB0
A13	IO43RSB0
A14	IO46RSB0
A15	IO55RSB0
A16	IO56RSB0
A17	GBC1/IO58RSB0
A18	GBA0/IO61RSB0
A19	GND
B1	GAA2/IO211RSB3
B2	VCCIB0
B3	GAB1/IO03RSB0
B4	GAC0/IO04RSB0
B5	IO11RSB0
B6	GND
B7	IO21RSB0
B8	IO22RSB0
B9	IO28RSB0
B10	IO32RSB0
B11	IO36RSB0
B12	IO39RSB0
B13	IO42RSB0
B14	GND
B15	IO52RSB0
B16	GBC0/IO57RSB0
B17	GBA1/IO62RSB0

CS281	
Pin Number	AGLP125 Function
B18	VCCIB1
B19	IO64RSB1
C1	GAB2/IO209RSB3
C2	IO210RSB3
C6	IO12RSB0
C14	IO47RSB0
C18	IO54RSB0
C19	GBB2/IO65RSB1
D1	IO206RSB3
D2	IO208RSB3
D4	GAA0/IO00RSB0
D5	GAA1/IO01RSB0
D6	IO10RSB0
D7	IO17RSB0
D8	IO24RSB0
D9	IO27RSB0
D10	GND
D11	IO31RSB0
D12	IO40RSB0
D13	IO49RSB0
D14	IO45RSB0
D15	GBB0/IO59RSB0
D16	GBA2/IO63RSB1
D18	GBC2/IO67RSB1
D19	IO66RSB1
E1	IO203RSB3
E2	IO205RSB3
E4	IO07RSB0
E5	IO06RSB0
E6	IO14RSB0
E7	IO20RSB0
E8	IO29RSB0
E9	IO34RSB0
E10	IO30RSB0
E11	IO37RSB0
E12	IO38RSB0

CS281	
Pin Number	AGLP125 Function
E13	IO48RSB0
E14	GBB1/IO60RSB0
E15	IO53RSB0
E16	IO69RSB1
E18	IO68RSB1
E19	IO71RSB1
F1	IO198RSB3
F2	GND
F3	IO201RSB3
F4	IO204RSB3
F5	IO16RSB0
F15	IO50RSB0
F16	IO74RSB1
F17	IO72RSB1
F18	GND
F19	IO73RSB1
G1	IO195RSB3
G2	IO200RSB3
G4	IO202RSB3
G5	IO08RSB0
G7	GAC2/IO207RSB3
G8	VCCIB0
G9	IO26RSB0
G10	IO35RSB0
G11	IO44RSB0
G12	VCCIB0
G13	IO51RSB0
G15	IO70RSB1
G16	IO75RSB1
G18	GCC0/IO80RSB1
G19	GCB1/IO81RSB1
H1	GFB0/IO191RSB3
H2	IO196RSB3
H4	GFC1/IO194RSB3
H5	GFB1/IO192RSB3
H7	VCCIB3

CS289



Note: This is the bottom view of the package.

Note

For Package Manufacturing and Environmental information, visit the Resource Center at <http://www.microsemi.com/soc/products/solutions/package/docs.aspx> .

CS289		CS289		CS289	
Pin Number	AGLP060 Function	Pin Number	AGLP060 Function	Pin Number	AGLP060 Function
G13	IO41RSB1	J17	GCA1/IO56RSB1	M4	IO122RSB3
G14	IO47RSB1	K1	GND	M5	GEB0/IO113RSB3
G15	IO49RSB1	K2	GFA0/IO135RSB3	M6	GEB1/IO114RSB3
G16	IO50RSB1	K3	GFB2/IO133RSB3	M7	NC
G17	GND	K4	IO128RSB3	M8	NC
H1	VCOMPLF	K5	IO123RSB3	M9	IO90RSB2
H2	GFB0/IO137RSB3	K6	IO125RSB3	M10	NC
H3	NC	K7	GND	M11	IO83RSB2
H4	IO141RSB3	K8	GND	M12	NC
H5	IO143RSB3	K9	GND	M13	GDA1/IO76RSB1
H6	GFB1/IO138RSB3	K10	GND	M14	GDA0/IO77RSB1
H7	GND	K11	GND	M15	IO71RSB1
H8	GND	K12	IO64RSB1	M16	IO69RSB1
H9	GND	K13	IO61RSB1	M17	VCCIB1
H10	GND	K14	IO66RSB1	N1	IO119RSB3
H11	GND	K15	IO65RSB1	N2	IO120RSB3
H12	GCC1/IO52RSB1	K16	GND	N3	GEC0/IO115RSB3
H13	IO51RSB1	K17	GCC2/IO60RSB1	N4	GEA0/IO111RSB3
H14	GCA0/IO57RSB1	L1	GFA2/IO134RSB3	N5	GND
H15	VCCIB1	L2	GFC2/IO132RSB3	N6	NC
H16	GCA2/IO58RSB1	L3	IO127RSB3	N7	IO104RSB2
H17	GCC0/IO53RSB1	L4	GND	N8	IO98RSB2
J1	VCCPLF	L5	IO121RSB3	N9	IO96RSB2
J2	GFA1/IO136RSB3	L6	GEC1/IO116RSB3	N10	VCCIB2
J3	VCCIB3	L7	GND	N11	NC
J4	IO131RSB3	L8	GND	N12	NC
J5	IO130RSB3	L9	VCC	N13	GDB2/IO79RSB2
J6	IO129RSB3	L10	GND	N14	NC
J7	VCC	L11	GND	N15	GND
J8	GND	L12	GDC1/IO72RSB1	N16	GDB0/IO75RSB1
J9	GND	L13	GDB1/IO74RSB1	N17	GDC0/IO73RSB1
J10	GND	L14	VCCIB1	P1	IO118RSB3
J11	VCC	L15	IO70RSB1	P2	IO117RSB3
J12	GCB2/IO59RSB1	L16	IO68RSB1	P3	GND
J13	GCB1/IO54RSB1	L17	IO67RSB1	P4	NC
J14	IO62RSB1	M1	IO126RSB3	P5	NC
J15	IO63RSB1	M2	VCCIB3	P6	IO106RSB2
J16	GCB0/IO55RSB1	M3	IO124RSB3	P7	IO99RSB2

CS289	
Pin Number	AGLP125 Function
G13	IO64RSB1
G14	IO69RSB1
G15	IO78RSB1
G16	IO76RSB1
G17	GND
H1	VCOMPLF
H2	GFB0/IO191RSB3
H3	IO195RSB3
H4	IO197RSB3
H5	IO199RSB3
H6	GFB1/IO192RSB3
H7	GND
H8	GND
H9	GND
H10	GND
H11	GND
H12	GCC1/IO79RSB1
H13	IO74RSB1
H14	GCA0/IO84RSB1
H15	VCCIB1
H16	GCA2/IO85RSB1
H17	GCC0/IO80RSB1
J1	VCCPLF
J2	GFA1/IO190RSB3
J3	VCCIB3
J4	IO185RSB3
J5	IO183RSB3
J6	IO181RSB3
J7	VCC
J8	GND
J9	GND
J10	GND
J11	VCC
J12	GCB2/IO86RSB1
J13	GCB1/IO81RSB1
J14	IO90RSB1
J15	IO89RSB1
J16	GCB0/IO82RSB1

CS289	
Pin Number	AGLP125 Function
J17	GCA1/IO83RSB1
K1	GND
K2	GFA0/IO189RSB3
K3	GFB2/IO187RSB3
K4	IO179RSB3
K5	IO175RSB3
K6	IO177RSB3
K7	GND
K8	GND
K9	GND
K10	GND
K11	GND
K12	IO88RSB1
K13	IO94RSB1
K14	IO95RSB1
K15	IO93RSB1
K16	GND
K17	GCC2/IO87RSB1
L1	GFA2/IO188RSB3
L2	GFC2/IO186RSB3
L3	IO182RSB3
L4	GND
L5	IO173RSB3
L6	GEC1/IO170RSB3
L7	GND
L8	GND
L9	VCC
L10	GND
L11	GND
L12	GDC1/IO99RSB1
L13	GDB1/IO101RSB1
L14	VCCIB1
L15	IO98RSB1
L16	IO92RSB1
L17	IO91RSB1
M1	IO184RSB3
M2	VCCIB3
M3	IO176RSB3

CS289	
Pin Number	AGLP125 Function
M4	IO172RSB3
M5	GEB0/IO167RSB3
M6	GEB1/IO168RSB3
M7	IO159RSB2
M8	IO161RSB2
M9	IO135RSB2
M10	IO128RSB2
M11	IO121RSB2
M12	IO113RSB2
M13	GDA1/IO103RSB1
M14	GDA0/IO104RSB1
M15	IO97RSB1
M16	IO96RSB1
M17	VCCIB1
N1	IO180RSB3
N2	IO178RSB3
N3	GEC0/IO169RSB3
N4	GDA0/IO165RSB3
N5	GND
N6	IO156RSB2
N7	IO148RSB2
N8	IO144RSB2
N9	IO137RSB2
N10	VCCIB2
N11	IO119RSB2
N12	IO111RSB2
N13	GDB2/IO106RSB2
N14	IO109RSB2
N15	GND
N16	GDB0/IO102RSB1
N17	GDC0/IO100RSB1
P1	IO174RSB3
P2	IO171RSB3
P3	GND
P4	IO160RSB2
P5	IO157RSB2
P6	IO154RSB2
P7	IO152RSB2

Revision	Changes	Page
Revision 13 (June 2012)	Figure 2-30 • FIFO Read and Figure 2-31 • FIFO Write have been added (SAR 34843).	2-73
	Updated the terminology used in Timing Characteristics in the following tables: Table 2-96 • FIFO and Table 2-97 • FIFO (SAR 38236).	2-76
	The following sentence was removed from the "VMVx I/O Supply Voltage (quiet)" section in the "Pin Descriptions and Packaging" section: "Within the package, the VMV plane is decoupled from the simultaneous switching noise originating from the output buffer VCCI domain" and replaced with "Within the package, the VMV plane biases the input stage of the I/Os in the I/O banks" (SAR 38320). The datasheet mentions that "VMV pins must be connected to the corresponding VCCI pins" for an ESD enhancement.	3-1
Revision 12 (March 2012)	The "In-System Programming (ISP) and Security" section and "Security" section were revised to clarify that although no existing security measures can give an absolute guarantee, Microsemi FPGAs implement the best security available in the industry (SAR 34664).	I, 1-2
	The Y security option and Licensed DPA Logo were added to the "IGLOO PLUS Ordering Information" section. The trademarked Licensed DPA Logo identifies that a product is covered by a DPA counter-measures license from Cryptography Research (SAR 34724).	III
	The "Specifying I/O States During Programming" section is new (SAR 34695).	1-7
	The following sentence was removed from the "Advanced Architecture" section: "In addition, extensive on-chip programming circuitry allows for rapid, single-voltage (3.3 V) programming of IGLOO PLUS devices via an IEEE 1532 JTAG interface" (SAR 34684).	1-3

Revision	Changes	Page
Revision 10 (Apr 2009) Product Brief v1.5 DC and Switching Characteristics Advance v0.5	The –F speed grade is no longer offered for IGLOO PLUS devices. References to it have been removed from the document. The speed grade column and note regarding –F speed grade were removed from "IGLOO PLUS Ordering Information". The "Speed Grade and Temperature Grade Matrix" section was removed.	III, IV
Revision 9 (Feb 2009) Product Brief v1.4	The "Advanced I/O" section was revised to add two bullets regarding support of wide range power supply voltage.	I
	The "I/Os with Advanced I/O Standards" section was revised to add 3.0 V wide range to the list of supported voltages. The "Wide Range I/O Support" section is new.	1-7
Revision 8 (Jan 2009) Packaging v1.5	The "CS201" pin table was revised to add a note regarding pins G1 and H1.	4-8
Revision 7 (Dec 2008) Product Brief v1.3	A note was added to IGLOO PLUS Devices: "AGLP060 in CS201 does not support the PLL."	I
	Table 2 • IGLOO PLUS FPGAs Package Size Dimensions was updated to change the nominal size of VQ176 from 100 to 400 mm ² .	II
Revision 6 (Oct 2008) DC and Switching Characteristics Advance v0.4	Data was revised significantly in the following tables: Table 2-25 • Summary of I/O Timing Characteristics—Software Default Settings, STD Speed Grade, Commercial-Case Conditions: T _J = 70°C, Worst-Case VCC = 1.425 V, Worst-Case VCCI = 3.0 V Table 2-26 • Summary of I/O Timing Characteristics—Software Default Settings, STD Speed Grade Commercial-Case Conditions: T _J = 70°C, Worst-Case VCC = 1.14 V, Worst-Case VCCI = 3.0 V Table 2-50 • 2.5 LVCMOS Low Slew – Applies to 1.2 V DC Core Voltage Table 2-51 • 2.5 V LVCMOS High Slew – Applies to 1.2 V DC Core Voltage	2-22, 2-33
Revision 5 (Aug 2008) Product Brief v1.2 Packaging v1.4	The VQ128 and VQ176 packages were added to Table 1 • IGLOO PLUS Product Family, the "I/Os Per Package" table, Table 2 • IGLOO PLUS FPGAs Package Size Dimensions, "IGLOO PLUS Ordering Information", and the "Temperature Grade Offerings" table.	I to IV
	The "VQ128" package drawing and pin table are new.	4-2
	The "VQ176" package drawing and pin table are new.	4-5
Revision 4 (Jul 2008) Product Brief v1.1 DC and Switching Characteristics Advance v0.3	As a result of the Libero IDE v8.4 release, Actel now offers a wide range of core voltage support. The document was updated to change 1.2 V / 1.5 V to 1.2 V to 1.5 V.	N/A
Revision 3 (Jun 2008) DC and Switching Characteristics Advance v0.2	Tables have been updated to reflect default values in the software. The default I/O capacitance is 5 pF. Tables have been updated to include the LVCMOS 1.2 V I/O set.	N/A
	Table note 3 was updated in Table 2-2 • Recommended Operating Conditions ^{1,2} to add the sentence, "VCCI should be at the same voltage within a given I/O bank." References to table notes 5, 6, 7, and 8 were added. Reference to table note 3 was removed from VPUMP Operation and placed next to VCC.	2-2
	Table 2-4 • Overshoot and Undershoot Limits ¹ was revised to remove "as measured on quiet I/Os" from the title. Table note 2 was revised to remove "estimated SSO density over cycles." Table note 3 was deleted.	2-3